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Vishay/Siliconix SI8424DB-T1-E1

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Vishay Siliconix

# N-Channel 1.2 V (G-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$ $I_{D}(A)^{i}$		Q <sub>g</sub> (Typ.)			
	0.031 at V <sub>GS</sub> = 4.5 V	12.2				
8	0.033 at V <sub>GS</sub> = 2.5 V	11.6				
	0.035 at V <sub>GS</sub> = 1.8 V	11.2	20 nC			
	0.043 at V <sub>GS</sub> = 1.5 V	10.2				
	0.077 at V <sub>GS</sub> = 1.2 V	1.3				

#### **MICRO FOOT**

Bump Side View

D



G

8424 XXX

Backside View

**Device Marking: 8424** 

xxx = Date/Lot Traceability Code

#### **FEATURES**

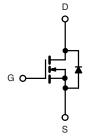
- TrenchFET® Power MOSFET
- Industry First 1.2 V Rated MOSFET
- Ultra Small MICRO FOOT® Chipscale Packaging Reduces Footprint Area, Profile (0.62 mm) and On-Resistance Per Footprint Area



Material categorization: For definitions of compliance please see www.vishav.com/doc?99912

#### **APPLICATIONS**

- · Low Threshold Load Switch for Portable Devices
  - Low Power Consumption
  - Increased Battery Life
- Ultra Low Voltage Load Switch



N-Channel MOSFET

Ordering Information: Si8424DB-T1-E1 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	$V_{DS}$	8	V		
Gate-Source Voltage		V <sub>GS</sub>	V <sub>GS</sub> ± 5		
	T <sub>C</sub> = 25 °C		12.2	A	
Continuous Drain Current /T _ 150 °C\	T <sub>C</sub> = 70 °C		9.8		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	8.1 <sup>b,c</sup>		
	T <sub>A</sub> = 70 °C		6.5 <sup>b,c</sup>		
Pulsed Drain Current		I <sub>DM</sub> 20			
	T <sub>C</sub> = 25 °C	1.	5.2		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.3 <sup>b,c</sup>		
	T <sub>C</sub> = 25 °C		6.25		
	T <sub>C</sub> = 70 °C	P <sub>D</sub>	4	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	r <sub>D</sub>	2.78 <sup>b,c</sup>		
	T <sub>A</sub> = 70 °C		1.78 <sup>b,c</sup>		
Operating Junction and Storage Temperature R	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Package Reflow Conditions <sup>d</sup> IR/Convection			260		

#### Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface mounted on 1" x 1" FR4 board.
- d. Refer to IPC/JEDEC (J-STD-020), no manual or hand soldering.
- e. In this document, any reference to the Case represents the body of the MICRO FOOT device and Foot is the bump.

Document Number: 74400 S13-1847-Rev. C, 19-Aug-13

For technical questions, contact: pmostechsupport@vishay.com

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Datasheet of SI8424DB-T1-E1 - MOSFET N-CH 8V 12.2A 2X2 4-MFP

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## **Si8424DB**

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THERMAL RESISTANCE RATINGS								
Parameter	Symbol	Тур.	Max.	Unit				
Maximum Junction-to-Ambient <sup>a,b</sup>	R <sub>thJA</sub>	35	45	°C/W				
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	16	20				

#### Notes

- a. Surface mounted on 1" x 1" FR4 board.
- b. Maximum under steady state conditions is 72 °C/W.

<b>SPECIFICATIONS</b> $(T_J = 2)$	Symbol	Test Conditions	Min.	Typ	Max.	Unit
Static	Symbol	Test Conditions	Wiin.	Тур.	wax.	Unit
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	8		1	V
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>	VGS = 0 V, ID = 230 μA	-	8.9		V
V <sub>GS(th)</sub> Temperature Coefficient		$I_D = 250 \mu A$		- 2.5		mV/°C
(- /	$\Delta V_{GS(th)}/T_J$	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	0.35	- 2.0	1	V
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ $V_{DS} = 0 \text{V}, V_{GS} = 5 \text{V}$	0.55		100	•
Gate-Source Leakage	I <sub>GSS</sub>	D0 7 Q0				nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 8 V, V <sub>GS</sub> = 0 V			1	μΑ
		$V_{DS} = 8 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 \text{ °C}$			10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20			Α
		$V_{GS} = 4.5 \text{ V}, I_D = 1 \text{ A}$		0.025	0.031	Ω
Dunin Course On Chata		$V_{GS} = 2.5 \text{ V}, I_D = 1 \text{ A}$		0.027	0.033	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 1 A		0.029	0.035	
nesistance.		V <sub>GS</sub> = 1.5 V, I <sub>D</sub> = 1 A		0.032	0.043	
		V <sub>GS</sub> = 1.2 V, I <sub>D</sub> = 1 A		0.049	0.077	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 4 \text{ V}, I_{D} = 1 \text{ A}$		8.3	13	S
Dynamic <sup>b</sup>			•		•	
Input Capacitance	C <sub>iss</sub>			1950		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 4 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		610		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			350		
Total Cata Charge		$V_{DS} = 4 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 1 \text{ A}$		22	33	
Total Gate Charge	Qg			20	30	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 4 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 1 \text{ A}$		3.5		nC
Gate-Drain Charge	$Q_{gd}$			1.8		
Gate Resistance	$R_{g}$	V <sub>GS</sub> = 0.1 V, f = 1 MHz		13		Ω
Turn-On Delay Time	t <sub>d(on)</sub>			8	12	
Rise Time	t <sub>r</sub>	$V_{DD} = 4 \text{ V, R}_{L} = 4 \Omega$ $I_{D} \cong 1 \text{ A, V}_{GEN} = -4.5 \text{ V, R}_{g} = 1 \Omega$		12	18	
Turn-Off Delay Time	t <sub>d(off)</sub>			110	165	ns
Fall Time	t <sub>f</sub>	- -		40	60	٦

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## **Si8424DB**

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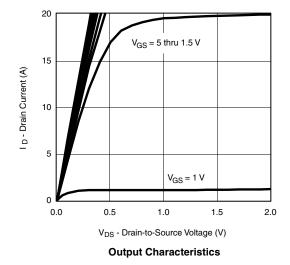
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions Min.		Тур.	Max.	Unit	
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			6.25		
Pulse Diode Forward Current	I <sub>SM</sub>				20	Α	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V		0.6	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			104	156	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = – 1 A, dl/dt = 100 A/μs, T <sub>.l</sub> = 25 °C		88	132	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$_{1F} = -1$ A, $_{10}$ $_{10$		26		no	
Reverse Recovery Rise Time	t <sub>b</sub>			78		ns	

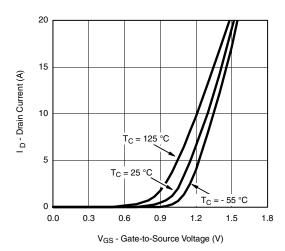
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)





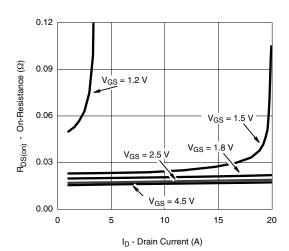
**Transfer Characteristics** 

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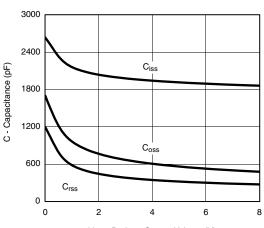


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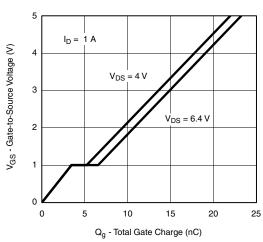
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



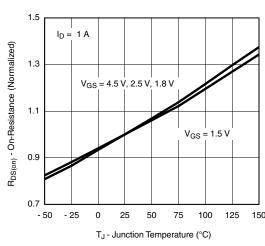
R<sub>DS(on)</sub> vs. Drain Current



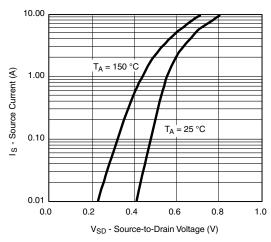
V<sub>DS</sub> - Drain-to-Source Voltage (V) Capacitance



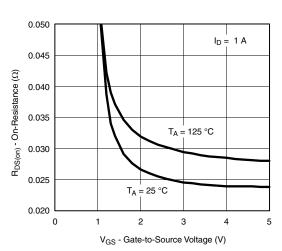
**Gate Charge** 



On-Resistance vs. Junction Temperature



Forward Diode Voltage vs Temp



R<sub>DS(on)</sub> vs V<sub>GS</sub> vs Temperature

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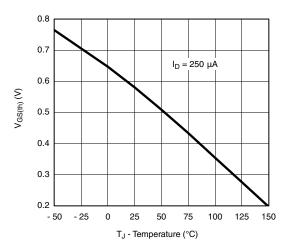
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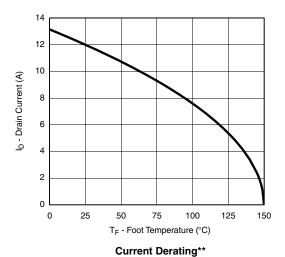


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## **TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)

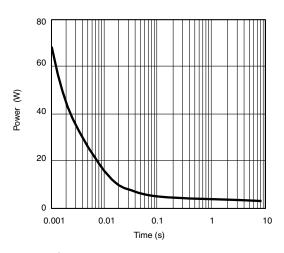


#### **Threshold Voltage**

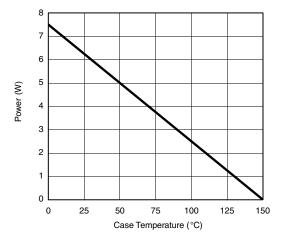




 $V_{DS}$  - Drain-to-Source Voltage (V) \*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



Single Pulse Power, Junction-to-Ambient



**Power Derating** 

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100

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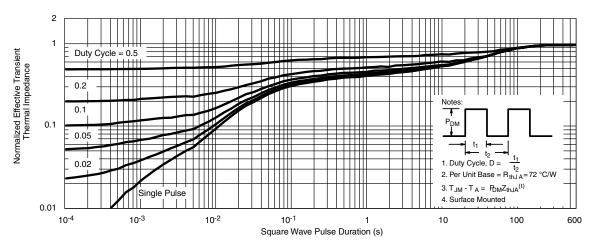
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<sup>\*\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max.)}$  = 150 °C, using junction-to-foot thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

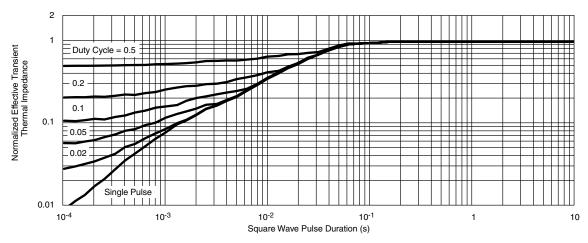


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## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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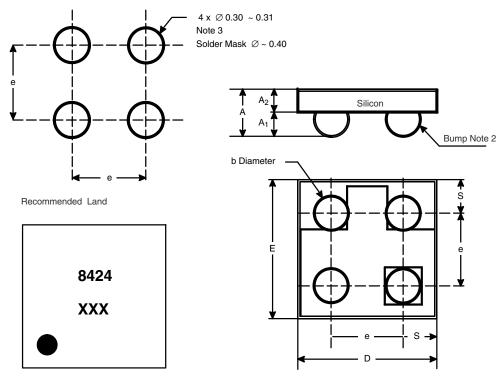


## **Si8424DB**

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#### **PACKAGE OUTLINE**

MICRO FOOT: 4-BUMP (0.8-mm PITCH)



Mark on Backside of Die

Notes (unless otherwise specified):

- 1. Laser mark on the silicon die back, coated with a thin metal.
- 2. Bumps are Sn/Ag/Cu.
- 3. Non-solder mask defined copper landing pad.
- 4. The flat side of wafers is oriented at the bottom.

Dim.	Millimeters <sup>a</sup>		Inches		
	Min.	Max.	Min.	Max.	
Α	0.600	0.650	0.0236	0.0256	
A <sub>1</sub>	0.260	0.290	0.0102	0.0114	
A <sub>2</sub>	0.340	0.360	0.0134	0.0142	
b	0.370	0.410	0.0146	0.0161	
D	1.520	1.600	0.0598	0.0630	
E	1.520	1.600	0.0598	0.0630	
е	0.800		0.0315		
S	0.360	0.400	0.0142	0.0157	

a. Use millimeters as the primary measurement.

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Revision: 13-Jun-16 1 Document Number: 91000